

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

the Application of: KIRA, et al.

Serial No.: 09/548,313

Filed: April 12, 2000

Group Art Unit: 265%

Examiner: Craig A. Renner

P.T.O. Confirmation No.: 6169

For: HEAD ASSEMBLY HAVING INTEGRATED CIRCUIT CHIP COVERED BY LAYER WHICH PREVENTS FOREIGN PARTICLE GENERATION

RECEIVE

FEB 0 9 2004

**AMENDMENT UNDER 37 CFR §1.111** 

Technology Center 2600

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

February 2, 2004

Sir:

In response to the Office Action dated October 2, 2003, extended to February 2, 2004 by a one month Petition for Extension of Time, please amend the above-identified application as follows:

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 3 of this paper.

Remarks/Arguments begin on page 15 of this paper.